

AND4RRA

InGaAIP High Brightness Red Chip LED with Right Angle Lens on Surface Mount Package Features

- 3.0 x 1.0 x 2.0 mm right angle SMD package
- · All plastic mold type, clear colorless lens
- Peak wavelength (λp=632nm) high bright emission
- Low drive current: 1 to 20 mA
- Compatible with automatic placement equipment
- Compatible with infrared & vapor phase reflow solder process
- · High efficiency
- RoHS Compliant

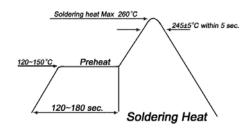
Maximum Ratings $(T_a = 25^{\circ}C)$

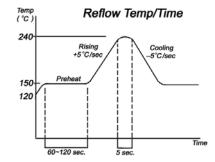
Characteristics	Symbol	Rating	Unit
Forward Current	I _F	25	mA
Pulse Voltage Current (Duty Cycle: 1/10 @ 1KHz)	I _{FP}	100	mA
Operating Temperature	T _{Opr}	-40 ~ +85	°C
Storage Temperature	T _{Stg}	-40 ~ +90	°C
Electrostatic Discharge	ESD	2000	V
Soldering Temperature	T _{Sol}	260 ±5 (<5 seconds)	°C
Power Dissipation	P _d	60	mW
Reverse Voltage	V _R	5	V

Electro-Optical Characteristics ($T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F = 20 mA	_	2.0	2.4	V
Reverse Current	I _R	V _R = 5 V	_	_	10	μA
Luminous Intensity	I _V	I _F = 20 mA	90	139	-	mcd
Peak Emission Wavelength	λ_{P}	I _F = 20 mA	_	632	-	nm
Spectral Line Half Width	λ_{d}	I _F = 20 mA	_	624	_	nm
Dominant Wavelength	λ/2	I _F = 20 mA	_	20	_	nm
Full Viewing Angle	θ	IV = 1/2 peak	_	120	_	degree

1. Recommended solder condition:





Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.





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